Overview

The engineering and scientific technical communities are seeing a vast digital and data-driven transformation in the ecosystems they currently operate in. This transformation includes significantly increased employment of machine learning, data science, large data sets, soft computing, augmented and virtual reality, digital twins for design, integration, and procurement — as well as new approaches that employ these approaches into classic deterministic and mechanics based models. These approaches hold significant potential.

The conference objective is to promote the development and application of machine learning and digital twins and digital engineering (MMLDE) technologies to the computational science and engineering (CSE) communities, a new series of IACM Special Interest Conferences entitled "Mechanistic Machine Learning And Digital Engineering for Computational Science, Engineering & Technology (MMLDE-CSET)" has been established with the second to be hosted at the University of Texas at El Paso during September 24-27 2023.

The main objective of MMLDE-CSET is to bring together the diverse communities that are interested in learning, developing, and applying machine learning and digital twins via computational science and engineering tools to a broad range of engineering and scientific problems. In addition, the conference seeks to promote collaborations between engineers, data and computer scientists, and mathematicians from federal agencies, academia, and industry in this field.

A strong focus will be to facilitate participation from engineering firms and computer and software companies to showcase industrial practice and identify challenges and needed MMLDE technologies in industry. In particular participation from individuals in the Advanced Manufacturing, Aerospace, and Autonomous Vehicle industries will be strongly promoted. To promote awareness of machine learning and digital twins to the general public, we will also organize special public lectures, short courses, and demonstrations open to STEM high school teachers and students from underprivileged schools in Texas and other states.

Conference Co-Chairs

Jack Chessa University of Texas at El Paso
Zhengtao Gan University of Texas at El Paso

Wing Kam Liu Northwestern University

J. S. Chen UC San Diego

Charbel Farhat Stanford University

Francisco Chinesta Arts et Métiers Institute of Technology

George Karniadakis Brown University
WaiChing Sun Columbia University

John Foster University of Texas at Austin

Dong Qian Mechanical Engineering, UT Dallas

2nd IACM CONFERENCE ON MECHANISTIC MACHINE LEARNING AND DIGITAL ENGINEERING FOR COMPUTATIONAL SCIENCE, ENGINEERING & TECHNOLOGY



www.utep.edu/engineering/mmlde/

Sept 24-27, 2023

The University of Texas at El Paso, El Paso, Texas, USA

The conference will take place with a hybrid format

Conference Topics

- 1. Multiscale Materials and Engineering Systems
- 2. Digital Twins in Aerospace and Defense
- 3. Machine learning finite element and numerical methods
- 4. Reduced-Order Modeling for Fluids, Solids, and Structures
- 5. MMLDT in STEM Education
- 6. Digital twins and mechanistic data science in additive manufacturing
- 7. Digital Thread in Product Lifecycle
- 8. Skills for Digital Workforce
- 9. Geosystems, geostatics
- 10. Mechanistic based machine learning for autonomous systems

To submit a proposal, complete the online form at: http://forms.usacm.org/mmlde-cset

In addition, short courses in *Mechanistic Data Science*, *Digital Engineering* and *Mechanistic Machine Learning* will be available before the start of the conference.















Multi-Institution Organizing Committees

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